

## **Materials Declaration Form**

IPC	1752	Version	2
Form Type *	Distribute	Version	4
Sectionals *	Material Info	Subsectionals *	A-D
	Manufacturing Info		* : Required Field

Supplier Information								
Company Name *	STMicroelectronics	Response Date *	2017-07-04					
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section					
Authorized Representative *	Antonella Lanzafame	Representative Title	AMG MD CHAMPION					
Representative Phone *	Refer to Supplier Comment section	Representative Email *	Refer to Supplier Comment section					
Sunnlier Comment	''	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html						

## **Uncertainty Statement**

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## Legal Statement

Supplier Acceptance \* true Legal Declaration \* Standard

## Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as omprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

Product								
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date				
LD39020ADTPU30R	MFBB*UAZ5AA5	А	Z8GA	2017-07-04				
	Amount UoM		Unit type	ST ECOPACK Grade				
	1.940	mg	Each	ECOPACK® 2				
,	Comment	ECOPACK® 2 is STMicroelectronics trade name for ROHS compliant device without Brominated and Chlorinated compound (900ppm) and without Antimony oxide flame retardant (in each organic material)						

Manufacturing information							
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles					
1	260	3					
bulk Solder Termination	Terminal Plating	Terminal Base Alloy	Comment	life.augmented			
NAC	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy		moragino			

Package Designator	Size	Nbr of instances	Shape	
QFN	1x1x0.38	4	No lead	
Comment				

QueryList: RoHS Directive 2011/65/EU-July 2011 – Annex II amended by Directive 2015/863-April 2015							
	Query	Response					
1 - Product(s) meets EU RoHS requirement without any exemptions							
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)							
3 - Product(s) meets EU RoHS requireme	nts by application of the selected exemption(s)	FALSE					
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions							
Exemption Id. Description							

ELV directive : 2000/53/EC amended 2016/774 _May 2016							
Query Response							
1 - Product(s) meets EU ELV requirements without any exemptions							
2 - Product(s) meets EU RoHS requireme	FALSE						
Exemption Id. Description							

Query : California Prop65 list, dated 27th January 2017							
Qu	Response						
1 - The product does not contain identified substance from California Prop 65 List, n	TRUE						
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen							
Substance	Application	ppm in product					
Nickel	2062						

QueryList: REACH-12th January 2017							
Query							
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH							
CategoryLevel_Name CategoryLevel_Threshold amount in product (mg) Application							

Asterial Composition Declaration:  ote: Substance present with less 0.001mg will not be declared in this document				Mfr Item Name	МҒВВ*Ц	JAZ5AA5			4999998.0	907472.0		
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die or Dies (choose)	Other inorganic materials	0.067	mg	supplier	die	Silicon (Si)	7440-21-3		0.061	mg	910448	31443
				supplier	metallization	Aluminium (Al)	7429-90-5		0.002	mg	29851	1031
				supplier	Passivation	Silicon Nitride	12033-89-5		0.001	mg	14925	515
				supplier	Passivation	Silicon Oxide	7631-86-9		0.003	mg	44776	1546
Leadframe	Copper and its alloy	1.808	mg	Supplier	Alloy	Copper(CU)	7440-50-8		1.779	mg	984098	829381
				Supplier	Alloy	Chromium(Cr)	7440-47-3		0.006	mg	3058	2577
				Supplier	Alloy	Zinc(Zn)	7440-66-6		0.004	mg	2446	2062
				Supplier	Alloy	Tin(Sn)	7440-31-5		0.007	mg	3058	2577
				Supplier	Alloy	Nickel (Ni)	7440-02-0		0.004	mg	2446	2062
				Supplier	Alloy	Palladium (Pd)	7440-05-3		0.004	mg	2446	2062
				Supplier	Alloy	Gold (Au)	7440-57-5		0.004	mg	2446	2062
Die Attach	Other Organic Material	0.042	mg	Supplier	Ероху	Silver(Ag)	7440-22-4		0.034	mg	789474	15464
				Supplier	Ероху	Ероху	proprietary		0.003	mg	78947	1546
				Supplier	Ероху	Anhydride	proprietary		0.003	mg	78947	1546
				Supplier	Ероху	Epoxy resin	25068-38-6		0.001	mg	26316	515
				Supplier	Ероху	Ethylene glycol monobutyl ether acetate	112-07-2		0.001	mg	26316	515
Bonding wire	Other Inorganic Material	0.020	mg	Supplier	Bonding wire	Gold(Au)	7440-57-5		0.020	mg	1000000	9278
Encapsulation	Other Organic Material	0.003	mg	Supplier	Molding compound	Epoxy Resin 1	proprietary		0.0001	mg	40000	52
				Supplier	Molding compound	Epoxy Resin 2	proprietary		0.0001	mg	40000	52
				Supplier	Molding compound	Phenol Resin	29690-82-2		0.0001	mg	40000	52
				Supplier	Molding compound	Metal hydroxide	21645-51-2		0.0002	mg	80000	103
				Supplier	Molding compound	Amorphous silica	60676-86-0		0.002	mg	800000	1031